FAIRCHILD SEMICONDUCTOR®

April 2009

HCPL0452, HCPL0453, HCPL0500, HCPL0501, HCPL0530, HCPL0531, HCPL0534
High Speed Transistor Optocouplers

Single Channel: HCPL0452 HCPL0453 HCPL0500 HCPL0501
Dual Channel: HCPL0530 HCPL0531 HCPL0534

Features

- High speed – 1 MBit/s
- 15kV/µs minimum commone mode transient immunity at V_{CM} = 1500V (HCPL0453/0534)
- Open collector output
- Guaranteed performance over temperature: 0°C to 70°C
- U.L. recognized (File # E90700)
- VDE0884 recognized (file#136616)
  – approval pending for HCPL0530/0531/0453
  – ordering option V, e.g., HCPL0500V
- BSI recognized (file# 8661, 8662)
  – HCPL0452/0500/0501 only

Applications

- Line receivers
- Pulse transformer replacement
- Output interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling

Description

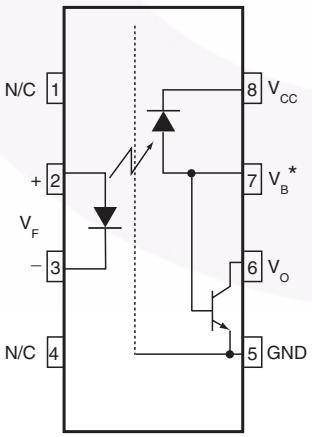
The HCPL05XX, and HCPL04XX optocouplers consist of an AlGaAs LED optically coupled to a high speed photo-detector transistor housed in a compact 8-pin small out-line package.

A separate connection for the bias of the photodiode improves the speed by several orders of magnitude over conventional phototransistor optocouplers by reducing the base-collector capacitance of the input transistor. The HCPL04XX devices do not have the base bonded out to a lead for additional noise margin. The HCPL053X devices have two channels per package for optimum mounting density.

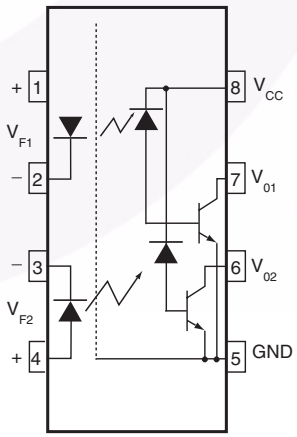
Truth Table
(positive Logic)

LED	Vo
ON	LOW
OFF	HIGH

Schematics



HCPL0500, HCPL0501
*BASE NOT CONNECTED
FOR HCPL0452, HCPL0453



HCPL0530/HCPL0531/HCPL0534

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units
T_{STG}	Storage Temperature	-40 to +125	°C
T_{OPR}	Operating Temperature	-40 to +85	°C
	Reflow Temperature Profile (Refer to page 11)		
EMITTER			
I_F (avg)	DC/Average Forward Input Current	25	mA
I_F (pk)	Peak Forward Input Current (50% duty cycle, 1ms P.W.)	50	mA
I_F (trans)	Peak Transient Input Current - ([≤1µs P.W., 300 pps)	1.0	A
V_R	Reverse Input Voltage	5	V
P_D	Input Power Dissipation	45	mW
DETECTOR			
I_O (avg)	Average Output Current (Pin 6)	8	mA
I_O (pk)	Peak Output Current	16	mA
V_{EBR}	Emitter-Base Reverse Voltage (HCPL0500/HCPL0501 only)	5	V
V_{CC}	Supply Voltage	-0.5 to 30	V
V_O	Output Voltage	-0.5 to 20	V
I_B	Base Current (HCPL0500/HCPL0501 only)	5	mA
P_D	Output power dissipation	100	mW

Electrical Characteristics (T_A = 0 to 70°C unless otherwise specified)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Typ.*	Max.	Unit
EMITTER							
V_F	Input Forward Voltage	I_F = 16mA, T_A = 25°C	All		1.45	1.7	V
		I_F = 16mA				1.8	
BV_R	Input Reverse Breakdown Voltage	I_R = 10µA	All	5.0			V
$\Delta V_F / \Delta T_A$	Temperature Coefficient of Forward Voltage	I_F = 16mA	All		-1.6		mV/°C
DETECTOR							
I_{OH}	Logic High Output Current	I_F = 0mA, V_O = V_{CC} = 5.5V, T_A = 25°C	All		0.001	0.5	µA
		I_F = 0mA, V_O = V_{CC} = 15V, T_A = 25°C	All		0.005	1	
		I_F = 0 mA, V_O = V_{CC} = 15V	All			50	
I_{CCL}	Logic Low Supply Current	I_F = 16mA, V_O = Open, V_{CC} = 15V	HCPL0452/3/ 0500/1		120	200	µA
			HCPL0530/1/4			400	
I_{CCH}	Logic High Supply Current	I_F = 0mA, V_O = Open, V_{CC} = 15V, T_A = 25°C	All		0.01	1	µA
		I_F = 0mA, V_O = Open, V_{CC} = 15V	HCPL0452/3/ 0500/1			2	
			HCPL0530/1/4			4	

Transfer Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Typ.*	Max.	Unit
COUPLED							
CTR	Current Tranfer Ratio (Note 1)	I_F = 16mA, V_O = 0.4V, V_{CC} = 4.5V, T_A = 25°C	HCPL0500/0530	7	2.7	50	%
			HCPL0452/3	19	27	50	
			HCPL0501/0531				
		I_F = 16mA, V_O = 0.5V, V_{CC} = 4.5V	HCPL0500	5	30		
			HCPL0452/3	15	30		
			HCPL0501/0534				
V_{OL}	Logic Low Output Voltage	I_F = 16mA, I_O = 1.1mA, V_{CC} = 4.5V, T_A = 25°C	HCPL0500		0.18	0.4	V
			HCPL0530			0.5	
		I_F = 16mA, I_O = 3mA, V_{CC} = 4.5V, T_A = 25°C	HCPL0452/3		0.25	0.4	
			HCPL0501/0531/4				
		I_F = 16mA, I_O = 0.8mA, V_{CC} = 4.5V	HCPL0500 HCPL0530		0.13	0.5	
		I_F = 16mA, I_O = 2.4mA, V_{CC} = 4.5V	HCPL0452/3		0.23	0.5	
			HCPL0501/0531/4				

*All typicals at T_A = 25°C

Electrical Characteristics (Continued) (T_A = 0 to 70°C unless otherwise specified)

Switching Characteristics TV_{CC} = 5V)

Symbol	Parameter	Test Conditions	Device	Min.	Typ.*	Max.	Unit
T_{PHL}	Propagation Delay Time to Logic LOW	T_A = 25°C, R_L = 4.1kΩ, I_F = 16mA (Note 2) (Fig. 9)	HCPL0500/0530		0.45	1.5	µs
		R_L = 1.9kΩ, I_F = 16mA, T_A = 25°C (Note 3) (Fig. 9)	HCPL0452/3		0.45	0.8	
			HCPL0501/0531/4				
		R_L = 4.1kΩ, I_F = 16mA (Note 2) (Fig. 9)	HCPL0500/0530			2.0	
		R_L = 1.9kΩ, I_F = 16mA (Note 3) (Fig. 9)	HCPL0452/3			1.0	
			HCPL0501/0531/4				
T_{PLH}	Propagation Delay Time to Logic HIGH	T_A = 25°C, R_L = 4.1kΩ, I_F = 16mA (Note 2) (Fig. 9)	HCPL0500/0530		0.5	1.5	µs
		R_L = 1.9kΩ, I_F = 16mA, T_A = 25°C (Note 3) (Fig. 9)	HCPL0452/3		0.3	0.8	
			HCPL0501/0531/4				
		R_L = 4.1kΩ, I_F = 16mA (Note 2) (Fig. 9)	HCPL0500/0530			2.0	
		R_L = 1.9kΩ, I_F = 16mA (Note 3) (Fig. 9)	HCPL0452/3			1.0	
			HCPL0501/0531/4				
$\|CM_H\|$	Common Mode Transient Immunity at Logic HIGH	I_F = 0mA, V_{CM} = 10V_{P-P}, R_L = 4.1kV, T_A = 25°C (Note 4) (Fig. 10)	HCPL0500	1,000	10,000		V/µs
			HCPL0530				
		I_F = 0mA, V_{CM} = 10V_{P-P}, R_L = 1.9kΩ T_A = 25°C, (Note 4) (Fig. 10)	HCPL0452	1,000	10,000		
			HCPL0501/31				
			HCPL0534	15,000	40,000		
		I_F = 16mA, V_{CM} = 1500V_{P-P}, R_L = 1.9Ω, T_A = 25°C (Note 4) (Fig. 10)	HCPL0453	15,000	40,000		
$\|CM_L\|$	Common Mode Transient Immunity at Logic LOW	I_F = 16mA, V_{CM} = 10V_{P-P}, R_L = 4.1kΩ, T_A = 25°C (Note 4) (Fig. 10)	HCPL0500	1,000	10,000		V/µs
			HCPL0530				
		I_F = 16 mA, V_{CM} = 10 V_{P-P}, R_L = 1.9kΩ (Note 4) (Fig. 10)	HCPL0452	1,000	10,000		
			HCPL0501/31				
			HCPL0534	15,000	40,000		
		I_F = 16mA, T_A = 25°C, V_{CM} = 1500 V_{P-P}, C_L = 15pF) (Note 4) (Fig. 10)	HCPL0453	15,000	40,000		

Isolation Characteristics

Symbol	Characteristics	Test Conditions	Min.	Typ.*	Max .	Unit
V_{ISO}	Input-Output Isolation Voltage	f = 60 Hz, t = 1.0 min., $I_{I-O} \le 2\mu A$ (Note 5, 6)	2500			Vac_{RMS}
R_{ISO}	Isolation Resistance	V_{I-O} = 500V (Note 5)	10^{11}			
C_{ISO}	Isolation Capacitance	V_{I-O} = 0 , f = 1.0MHz (Note 5)		0.2		pF

*All typicals at T_A = 25°C

Notes

1 Current Transfer Ratio is designed as a ratio of output collector current, I_O, to the forward LED input current, I_F, times 100%.

2. The 4.1 kΩ load represents 1 LSTTL unit load of 0.36 mA and 6.1kΩ pull-up resistor.

3. The 1.9 kΩ load represents 1 TTL unit load of 1.6 mA and 5.6 kΩ pull-up resistor.

4. Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm}/dt on the leading edge of the common mode pulse signal V_{CM}, to assure that the output will remain in a logic high state (i.e., V_O>2.0 V). Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm}/dt on the trailing edge of the common mode pulse signal, V_{CM}, to assure that the output will remain in a logic low state (i.e., V_O<0.8 V).

5. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.

6. 2500 VAC RMS for 1 minute duration is equivalent to 3000 VAC RMS for 1 second duration.

Typical Performance Curves

Fig. 1 Normalized CTR vs. Forward Current

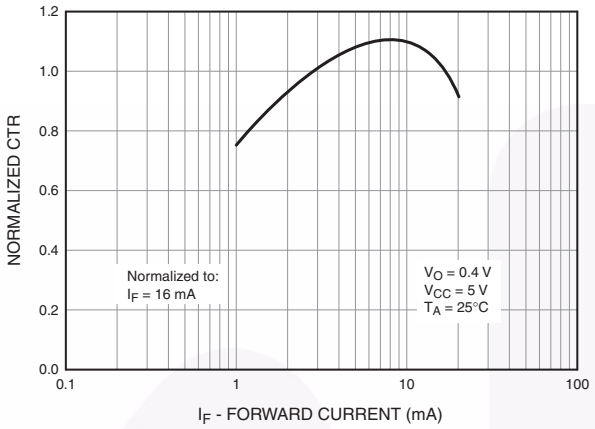


Fig. 2 Normalized CTR vs. Temperature

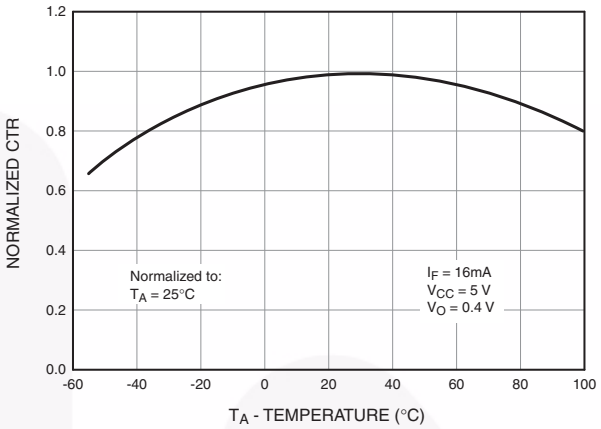


Fig. 3 Output Current vs. Output Voltage

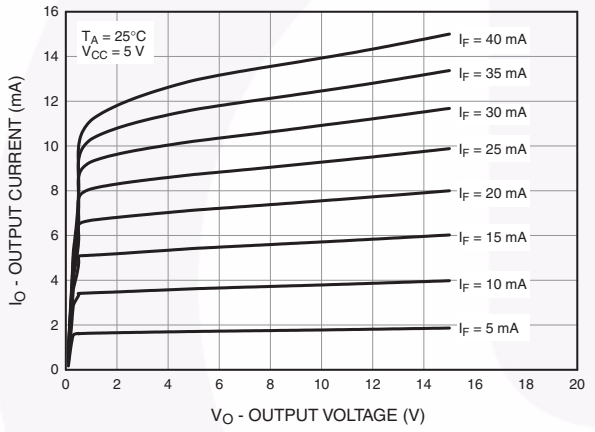


Fig. 4 Logic High Output Current vs. Temperature

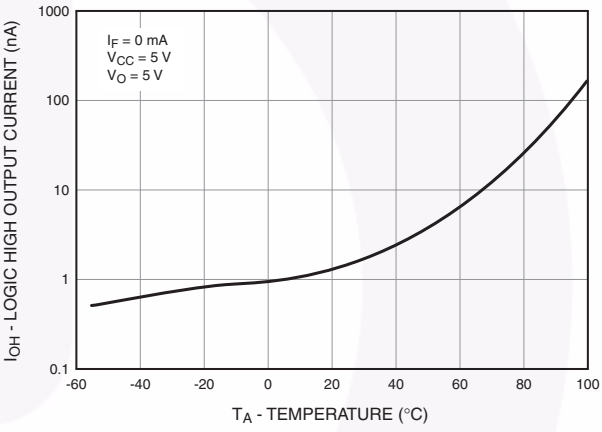


Fig. 5 Propagation Delay vs. Temperature

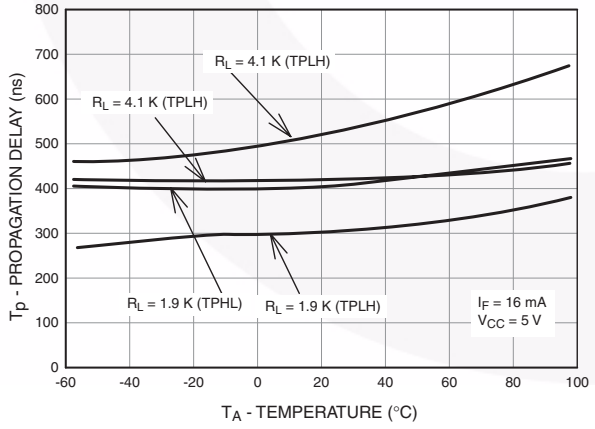
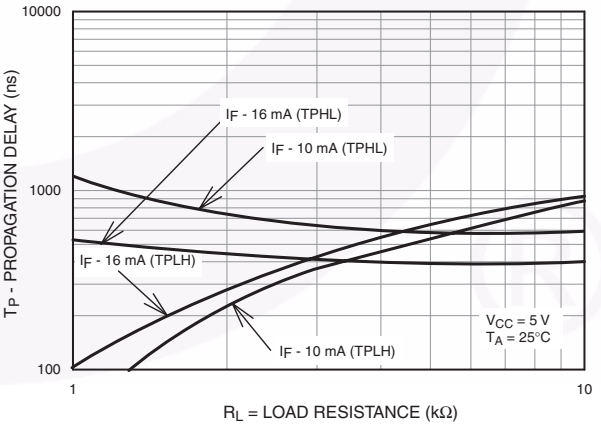
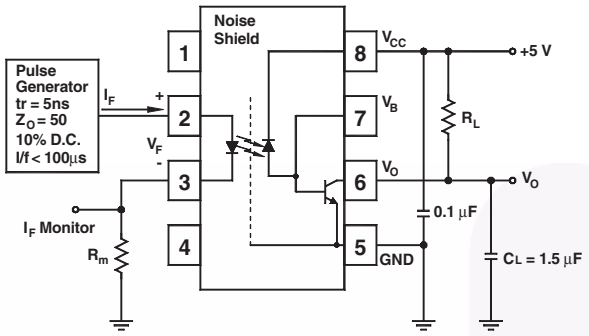
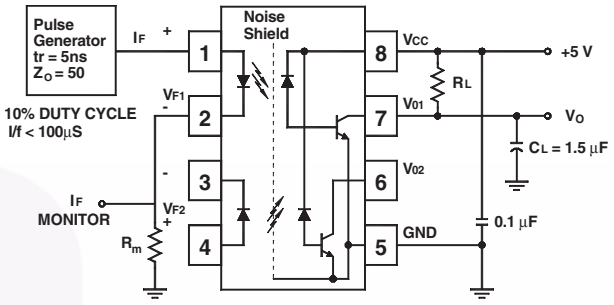


Fig. 6 Propagation Delay vs. Load Resistance





Test Circuit for HCPL0452, HCPL0453, HCPL0500 and HCPL0501



Test Circuit for HCPL0530, HCPL0531 and HCPL0534

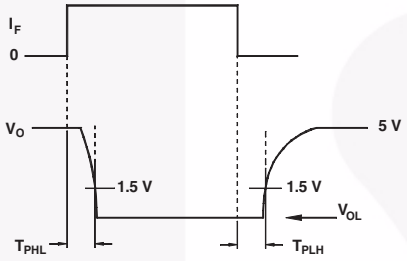
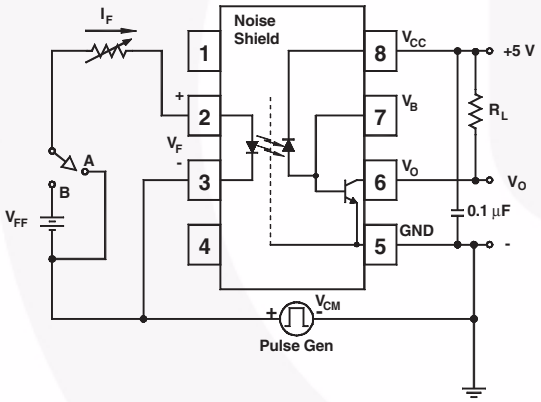
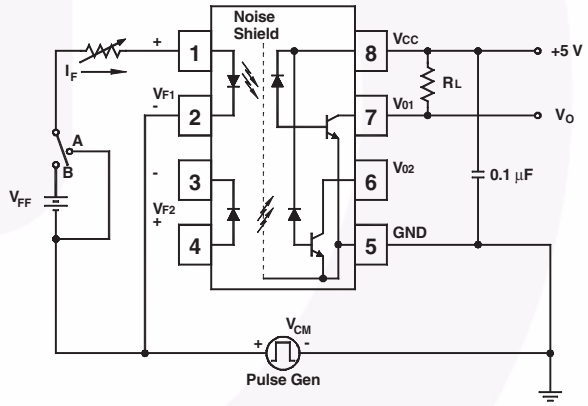


Fig. 7 Switching Time Test Circuit



Test Circuit for HCPL0452, HCPL0453, HCPL0500 and HCPL0501



Test Circuit for HCPL0530, HCPL0531 and HCPL0534

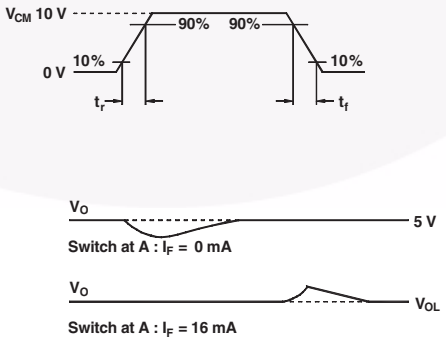
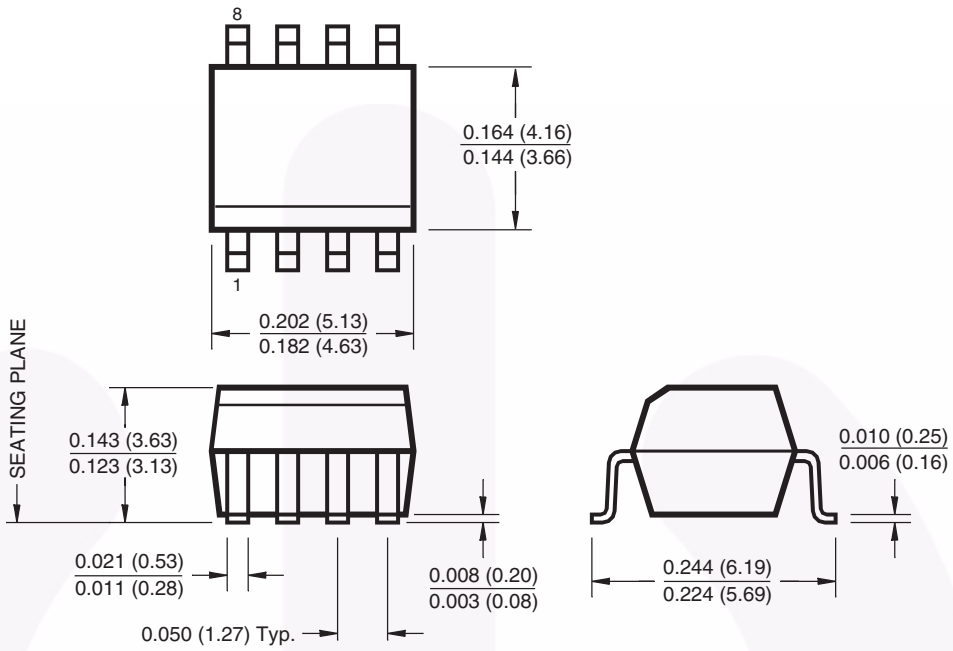


Fig. 8 Common Mode Immunity Test Circuit

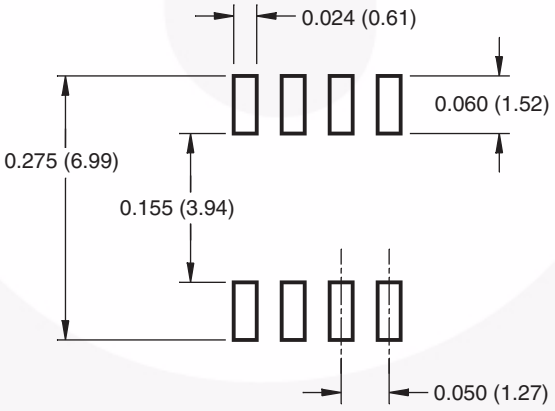
Package Dimensions

8-pin SOIC Surface Mount



Lead Coplanarity: 0.004 (0.10) MAX

Recommended Pad Layout



Dimensions in inches (mm).

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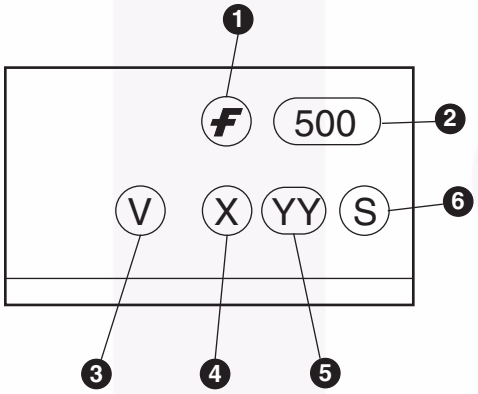
Ordering Information

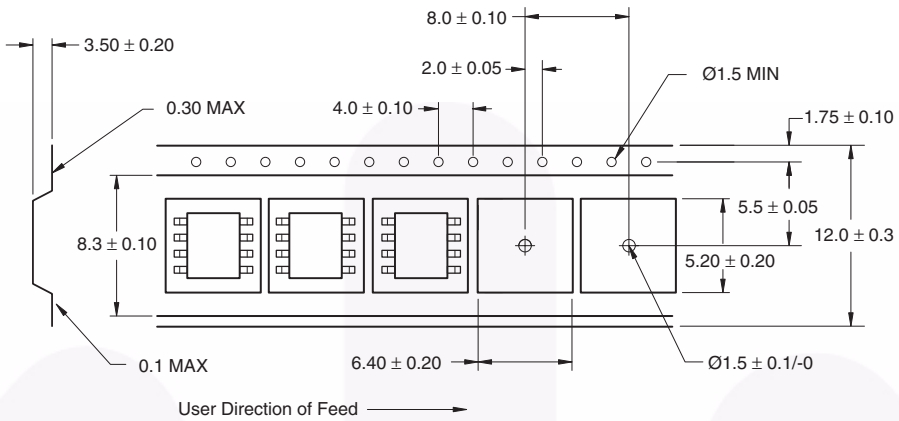
Option	Order Entry Identifier	Description
V	V	VDE 0884 (approval pending for HCPL0530, HCPL0531 & HCPL0534)
R2	R2	Tape and reel (2500 units per reel)
R2V	R2V	VDE 0884 (approval pending for HCPL0530, HCPL0531 & HCPL0534), Tape and reel (2500 units per reel)

Marking Infomation

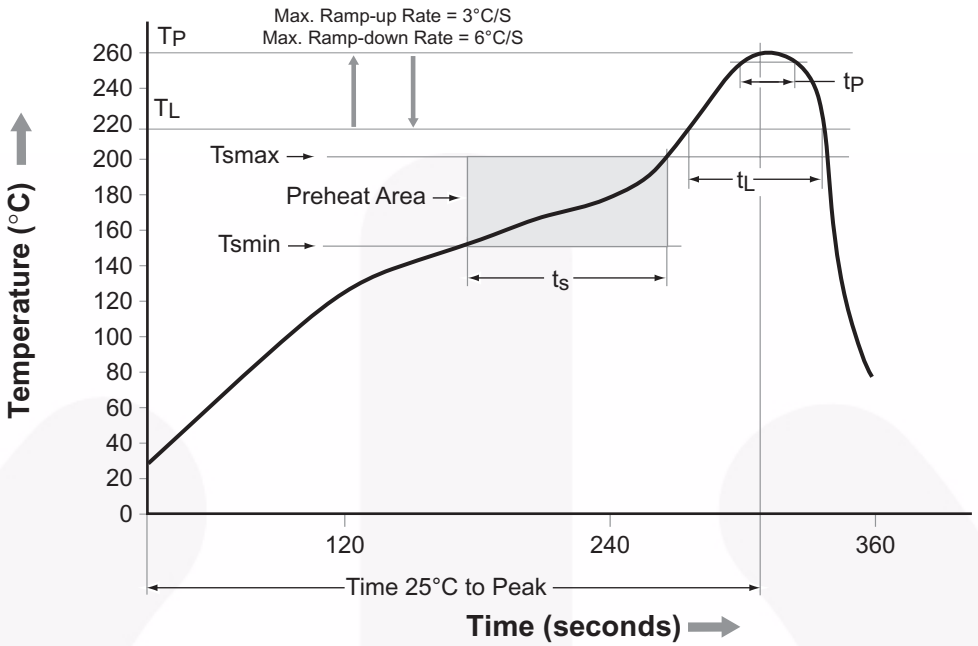


Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code, e.g., ‘3’
5	Two digit work week ranging from ‘01’ to ‘53’
6	Assembly package code

Carrier Tape Specifications



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t_S) from (Tsmin to Tsmax)	60–120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60–150 seconds
Peak Body Package Temperature	260°C +0°C / –5°C
Time (t_P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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